776200-1 - ACTIVE

AMP | AMPSEAL

TE Internal #: 776200-1 PCB Mount Header, Vertical, Wire-to-Board / Wire-to-Device, 23 Position, .157 in [4 mm] Centerline, Fully Shrouded, Tin (Sn), AMPSEAL

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Connector System: Wire-to-Board, Wire-to-Device

Number of Positions: 23

Centerline (Pitch): 4 mm [.157 in]

Sealable: Yes

PCB Mount Orientation: Vertical

All AMPSEAL PCB Headers (32)

Features

Product Type Features

Hybrid Header

Connector & Housing Shape	Rectangular
PCB Connector Assembly Type	PCB Mount Header
Header Type	Fully Shrouded
Connector System	Wire-to-Board, Wire-to-Device
Sealable	Yes
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Number of Sections	1
Number of Signal Positions	23
Number of Positions	23
PCB Mount Orientation	Vertical
Number of Rows	3
Electrical Characteristics	
Voltage Rating (Max)	250 VAC
Nominal Voltage Architecture	12 V, 24 V, 42 V, 48 V, 240 V

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Operating Voltage	250 VAC
Body Features	
Primary Product Color	Black
Connector Code	14, 4
Contact Features	
Contact Size	1.3mm
Contact Type	Pin
Mating Pin Diameter	1.3 mm[.051 in]
Contact Mating Area Plating Material	Tin (Sn)
Termination Features	
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
Mounting Holes	With
Mating Alignment Type	Keyed
Mating Retention	With
Mating Alignment	With
PCB Mount Alignment	With

Panel Mount Feature	Without
PCB Mount Retention	Without
PCB Mount Retention Type	Solder Tail
Mating Retention Type	Locking Interface
Connector Mounting Type	Board Mount
Housing Features	
Centerline (Pitch)	4 mm[.157 in]
Dimensions	
Connector Length	60.8 mm[2.394 in]
Connector Width	32.1 mm[1.264 in]
PCB Thickness (Recommended)	1.57 mm[.062 in]
Profile Height from PCB	34.25 mm[1.348 in]
Usage Conditions	
Operating Temperature (Max)	65 °C, 70 °C, 75 °C, 80 °C, 85 °C, 90 °C, 100 °C, 105 °C[149 °F][158 °F][167 °F][176 °F] [185 °F][194 °F][212 °F][221 °F]

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Operating Temperature Range	-40 – 105 °C[-40 – 221 °F]
Operation/Application	
Shielded	No
Circuit Application	Power & Signal
Industry Standards	
Degree of Protection	IP67, IP69K
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	1
Product Compliance For compliance documentation, visit the product page on TE.com> EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JUNE

2022 (224) Does not contain REACH SVHC

Not Low Halogen - contains Br or Cl > 900 ppm.

Wave solder capable to 265°C

Halogen Content

Solder Process Capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

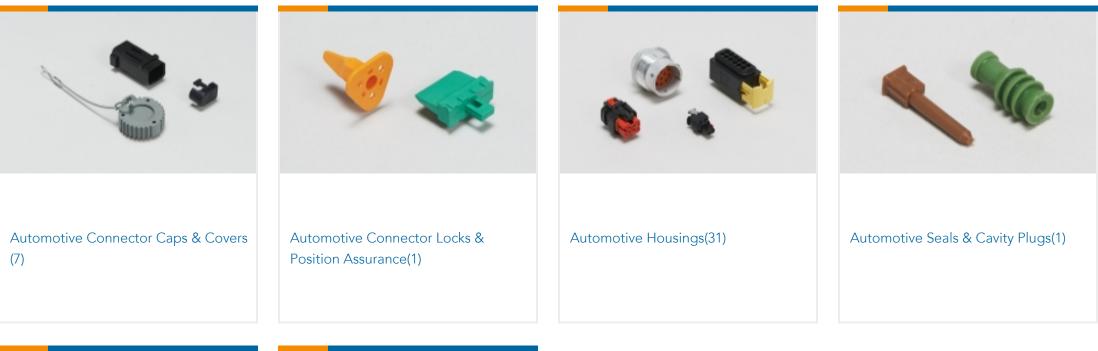
Compatible Parts

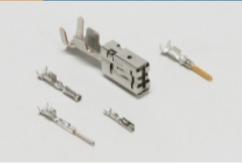
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Also in the Series | AMPSEAL

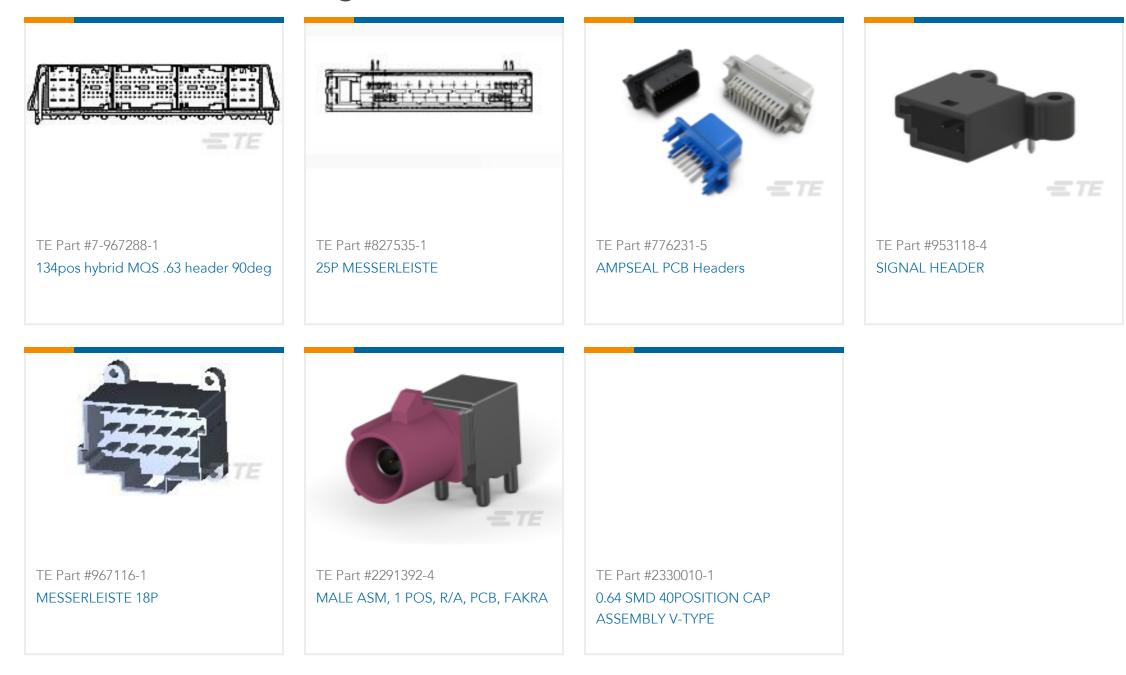






Automotive Terminals(8) PCB Headers & Receptacles(72)

Customers Also Bought



PCB Mount Header, Vertical, Wire-to-Board / Wire-to-Device, 23 Position, .157 in [4 mm] Centerline, Fully Shrouded, Tin (Sn), AMPSEAL



Documents

Product Drawings 23POS, PIN DIA 1.3, HDR ASSY, 180DEG, SLDR

English

CAD Files

Customer View Model ENG_CVM_776200-1_D3.3d_igs.zip

English

Customer View Model

ENG_CVM_776200-1_D3.3d_stp.zip

English

Customer View Model

ENG_CVM_776200-1_D3.2d_dxf.zip

English

3D PDF

English

3D PDF

3D

Customer View Model

ENG_CVM_CVM_776200-1_G.2d_dxf.zip

English

Customer View Model ENG_CVM_CVM_776200-1_G.3d_igs.zip

English

Customer View Model ENG_CVM_CVM_776200-1_G.3d_stp.zip

English

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Datasheets & Catalog Pages

AMPSEAL Connector Catalog

English

ICT Terminals and Connectors Catalogue

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CONNECTOR SELECTOR

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Product Specifications

Application Specification

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Agency Approvals

UL Report

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